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| Notice of References Cited | Application/Control No. 10/608,605 | Applicant(s)/Patent Under Reexamination LEE ET AL. | |
| | Examiner Thomas J. Magee | Art Unit 2811 | Page 1 of 1 |

U.S. PATENT DOCUMENTS

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| | P | | | | | |
| | Q | | | | | |
| | R | | | | | |
| | S | | | | | |
| | T | | | | | |

NON-PATENT DOCUMENTS

| * | | Include as applicable: Author, Title Date, Publisher, Edition or Volume, Pertinent Pages) |
|---|---|---|
| | U | Johannes Adam, "New Correlations Between Electrical Current and Temperature Rise in PCB Traces," Proc. 20 th IEEE Semi-Therm Symp., (March,2004), pp. 1-8. |
| | V | |
| | W | |
| | X | |

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